

IMPI 60 ATTENDEE LIST

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FIRST	LAST	COMPANY	LOCATION
Kostiantyn	Achkasov	Applied Materials	Santa Clara, CA, USA
Adejoke	Adewumi	Louisiana State University	Baton Rouge, LA, USA
Juan	Aguilar-Garib	Universidad Autonoma de Nuevo Leon	San Nicolas de lo Garza, Nuevo Leon, Mexico
Noah	Anderson	The University of Tennessee, Knoxville	Memphis, TN, USA
Hueseyin	Ates	Muegge GmbH	Reichelsheim, Germany
Benjamin	Ballart	Sairem	Peachtree Corners, GA, USA
Casey	Barber	Rivendell Technologies	Greenwich, CT, USA
Jon	Barry	Stellant Systems, Inc.	Williamsport, PA, USA
Jean-Paul	Bernard	Microwave Industrial Solutions	Lyon, France
Scott	Best	SiberSci, LLC	Owensboro, KY, USA
Mo	Bhuyan	Crescend Technologies	Glendale Heights, IL, USA
Vladimir	Bilik	S-TEAM Lab	Bratislava, Slovak Republic
Maria	Bilikova	S-TEAM	Bratislava, Slovak Republic
Brian	Blackwell	Microwave Techniques, LLC	Gorham, ME, USA
Jonny	Blanchette	Microwave Techniques, LLC	Nashua, NH, USA
Raymond	Boxman	Tel Aviv University	Tel Aviv, Israel
Eric	Brown	Conagra Brands	Omaha, NE, USA
Ralph	Bruce	RWBruce Associates LLC	Joelton, TN, USA
Melissa	Bryan	Conagra Brands	Omaha, NE, USA
Malgorzata	Celuch	IEEE MTT-S	Warsaw, Poland
Jiajia	Chen	University of Tennessee - Knoxville	Knoxville, TN, USA
Su-Der	Chen	National Ilan University	Yilan City, Taiwan
Gwang-Mun	Choi	Electronics and Telecommunications Research Institute	Daejeon, Korea
Jerome	Czajkowski	Richardson Electronics	La Fox, IL, USA
Jim	Detert	Microwave Techniques, LLC	Gorham, ME, USA
Markus	Dingeldein	Muegge GmbH	Reichelsheim, Germany
Sayurio	Doi	Kanematsu	Tokyo, Japan
Gabriela	Duran-Jimenez	University of Nottingham	Nottingham, United Kingdom
Candice	Ellison	USDA-ARS	Wyndmoor, PA, USA
Ulrich	Erle	Consultant	Cleveland, OH, USA
Mark	Fitzgerald	Microwave Techniques, LLC	Nashua, NH, USA
Francesco	Garuti	MKS	Reggio Emilia, Italy
John	Gerling	Gerling Consulting, Inc.	Gilroy, CA, USA
Jay	Guilmette	Microwave Techniques, LLC	Portland, ME, USA
Jon	Hamilton	Teledyne Brown Engineering	Oak Ridge, TN, USA
Lou	Honary	WAVEtek Process Technology, LLC	Grundy Center, IA, USA
YoonKi	Hong	SAIREM Corp.	Peachtree Corners, GA, USA
Hiro	Ito	Kanematsu USA	Schaumburg, IL, USA
Marie	Jirsa	Kraft Heinz	Oak Park, IL, USA
Herminie	Joessel	WAVEPIA Co., Ltd.	Hwaseong-si, South Korea
Adam	Jones	Crescend Technologies	Windam, ME, USA
Andrew	Juodis	Richardson Electronics	La Fox, IL, USA
Navneet	Kallapalli	Rivendell Technologies	Kanata, Ontario, Canada
Mohammad	Kamarehi	MKS	Lexington, MA, USA
Adyson	Koetter	Worcester Polytechnic Institute	Worcester, MA, USA
Jim	Krombach	Alkar	Lodi, WI, USA
KiWook (Daniel)	Lee	WAVEPIA Co., Ltd.	Hwaseong-si, South Korea
Haoyang	Li	University of Toronto	Toronto, Canada
Guido	Link	KIT – The Research University in the Helmholtz-Association	Eggenstein-Leopoldshafen, Germany
Michael	Luethi	MUEGGE-Gerling North America	Modesto, CA, USA
Warren	Lundy	Rivendell Technologies	Carleton Place, Ontario, Canada
John	Mastela	JFM Technical Corporation	New Lenox, IL, USA
Sean	McKeown	Graphic Packaging International	Louisville, CO, USA
Ariel	Nause	Ariel University	Shderot Hamada, Israel
Balu	Nayak	PepsiCo.	Plano, TX, USA
Emilie	O'Brien	The Elmet Group	Portland, ME, USA

Mamdouh	Omran	University of Oulu	Oulu, Finland
Geoff	Paul	Rivendell Technologies	Almonte, Canada
Lukas	Pecuch	S-TEAM	Bratislava, Slovak Republic
Molly	Poisant	IMPI	Mechanicsville, VA, USA
Adam	Ritscher	Ampleon	Smithfield, RI, USA
Mark	Robertson	Rivendell Technologies	Kanata, Ontario, Canada
Pablo	Santón	pinkRF	Majorca, Spain
Houssem	Schuick	Ampleon	Nijmegen, Netherlands
Kazu	Sekine	Kanematsu	Somerset, NJ, USA
Chris	Sexton	Teledyne Brown Engineering	Oak Ridge, TN, USA
Piyush	Sharma	National Institute of Technology Rourkela	Rourkela, Odisha, India
Naoki	Shinohara	Kyoto University	Kyoto, Japan
Holly	Shulman	Afred University	Belmont, NY, USA
Raphael	Speck	Herrenknecht AG	Offenburg, Germany
Alicia	Standridge	IMPI	Mechanicsville, VA, USA
Greg	Stromotich	NuWave Research Inc.	North Vancouver, BC, Canada
Jacob	Sturgis	Microwave Techniques, LLC	Portland, ME, USA
Shin	Sugano	Kanematsu	Tokyo, Japan
Mehmet	Sucu	EnWave Corporation	Delta, British Columbia, Canada
Chiva	Sum	Kyushu University	Fukuoka, Japan
Samir	Trabelsi	USDA-ARS	Athens, GA, USA
Shuntaro	Tsubaki	Kyushu University	Fukuoka, Japan
Juergen	Uebbing	Muegge GmbH	Reichelsheim, Germany
Francois	Van der Merwe	Aurora Hydrogen	Edmonton, Alberta, Canada
Stephanie	Varga	Stellant Systems, Inc.	Williamsport, PA, USA
Ross	Vargason	Applied Microwaves Technology	Cedar Rapids, IA, USA
David	Vennin	SAIREM	Neyron, France
Harry	Vine	Osenza	North Caldwell, NY, USA
Rocco	Wall	Stellant Systems, Inc.	Williamsport, PA, USA
Charles	Wang	Kraft Heinz Company	Wexford, PA, USA
Klaus	Werner	pinkRF	Nijmegen, The Netherlands
Jerry	Wessel	Richardson Electronics	La Fox, IL, USA
Roger	Williams	3D RF Energy Corp.	Cranston, RI, USA
Michael	Wolf	The Spoon, CES Food Tech, Smart AI Summit, SKS	Edmonds, WA, USA
Vadim	Yakovlev	Worcester Polytechnic Institute	Worcester, MA, USA
Xu	Zhou	The Pennsylvania State University	State College, PA, USA